UNITRODE

UC1901
UC2901
UC3901

Isolated Feedback Generator

FEATURES

- An Amplitude-Modulation System for Transformer Coupling an Isolated Feedback Error Signal
- Low-Cost Alternative to Optical Couplers
- Internal 1% Reference and Error Amplifier
- Internal Carrier Oscillator Usable to 5MHz
- Modulator Synchronizable to an External Clock
- Loop Status Monitor

DESCRIPTION

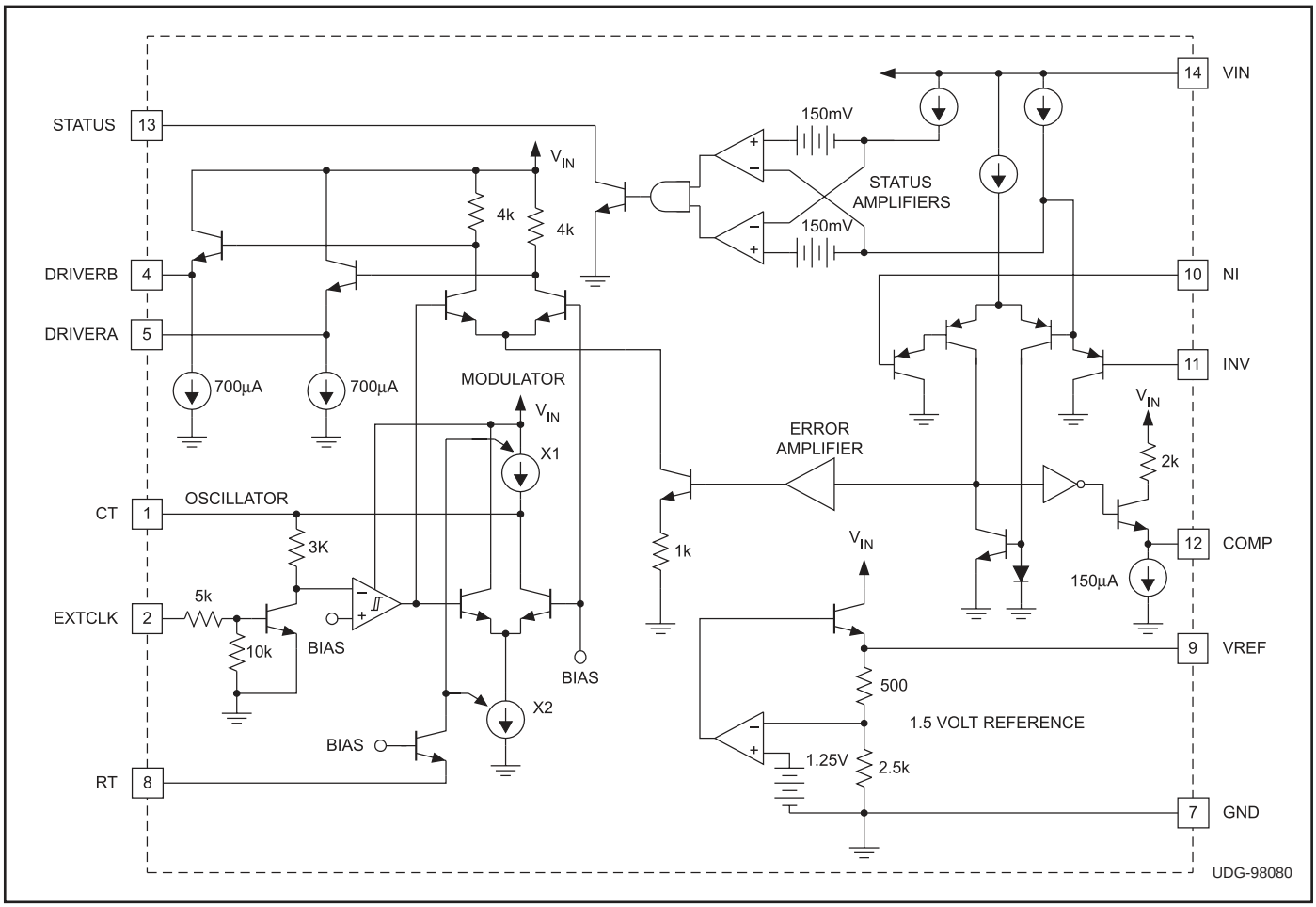
The UC1901 family is designed to solve many of the problems associated with closing a feedback control loop across a voltage isolation boundary. As a stable and reliable alternative to an optical coupler, these devices feature an amplitude modulation system which allows a loop error signal to be coupled with a small RF transformer or capacitor.

The programmable, high-frequency oscillator within the UC1901 series permits the use of smaller, less expensive transformers which can readily be built to meet the isolation requirements of today's line-operated power systems. As an alternative to RF operation, the external clock input to these devices allows synchronization to a system clock or to the switching frequency of a SMPS.

An additional feature is a status monitoring circuit which provides an active-low output when the sensed error voltage is within ±10% of the reference. The DRIVERA output, DRIVERB output, and STATUS output are disabled until the input supply has reached a sufficient level to allow proper operation of the device.

Since these devices can also be used as a DC driver for optical couplers, the benefits of 4.5 to 40V supply operation, a 1% accurate reference, and a high gain general purpose amplifier offer advantages even though an AC system may not be desired.

UC1901 SIMPLIFIED SCHEMATICNovember S



ABSOLUTE MAXIMUM RATINGS *(Note 1)*

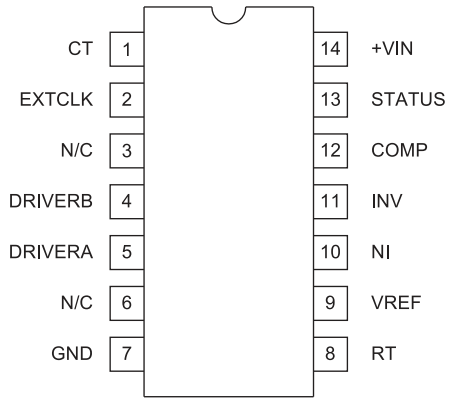
Input Supply Voltage, V_{IN} 40V
Reference Output Current . . . . . –10mA
Driver Output Currents . . . . . –35mA
Status Indicator Voltage 40V
Status Indicator Current 20mA
Ext. Clock Input 40V
Error Amplifier Inputs . . . . . –0.5V to +35V
Power Dissipation at T_A = 25°C 1000mW
Power Dissipation at T_C = 25°C 2000mW
Operating Junction Temperature . . . . . –55°C to +150°C
Storage Temperature . . . . . –65°C to +150°C
Lead Temperature (Soldering, 10 seconds) . . . . . 300°C

Note 1*: Voltages are referenced to ground, Pin 7. Currents are positive into, negative out of the specified terminal.*

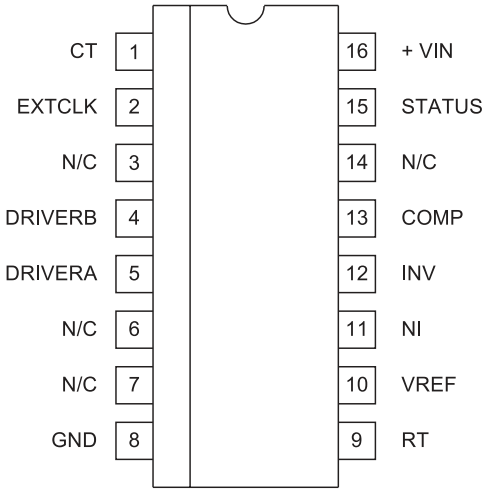
Note 2*: Consult Packaging section of Databook for thermal limitations and considerations of package.*

CONNECTION DIAGRAMS

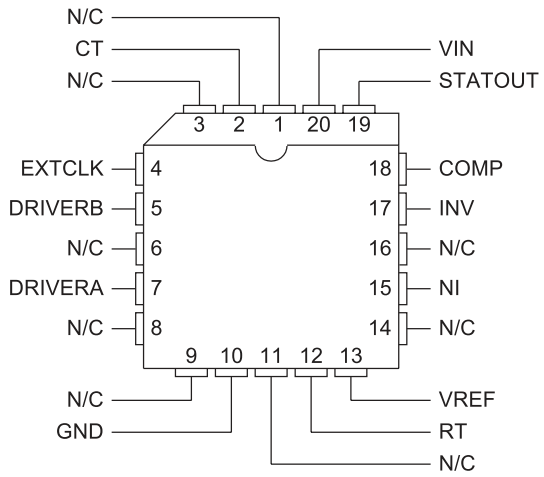
DIL-14, SOIC-14 (TOP VIEW)
J or N Package, D Package



SOIC-16 Wide (TOP VIEW)
DW Package



PLCC-20, LCC-20 (TOP VIEW)
Q, L Packages



TEMPERATURE AND PACKAGE SELECTION GUIDE

	TEMPERATURE RANGE	AVAILABLE PACKAGES
UC1901	–55°C to +125°C	J, L
UC2901	–40°C to +85°C	D, DW, J, N, Q
UC3901	0°C to +70°C	D, DW, J, N, Q

ELECTRICAL CHARACTERISTICS Unless otherwise stated, these specifications apply for V_{IN} = 10V, R_T = 10kΩ, C_T = 820pF, $T_A = T_J$.

PARAMETER	TEST CONDITIONS	UC1901/UC2901			UC3901			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
Reference Section								
Output Voltage	T_J = 25°C	1.485	1.5	1.515	1.47	1.5	1.53	V
	$T_{MIN} \le T_J \le T_{MAX}$	1.470	1.5	1.530	1.455	1.5	1.545	
Line Regulation	V_{IN} = 4.5 to 35V		2	10		2	15	mV
Load Regulation	I_{OUT} = 0 to 5mA		4	10		4	15	mV
Short Circuit Current	T_J = 25°C		–35	–55		–35	–55	mV
Error Amplifier Section (To Compensation Terminal)								
Input Offset Voltage	V_{CM} = 1.5V		1	4		1	8	mV
Input Bias Current	V_{CM} = 1.5V		–1	–3		–1	–6	µA
Input Offset Current	V_{CM} = 1.5V		0.1	1		0.1	2	µA
Small Signal Open Loop Gain		40	60		40	60		dB
CMRR	V_{CM} = 0.5 to 7.5V	60	80		60	80		dB
PSRR	V_{IN} = 5 to 25V	80	100		80	100		dB
Output Swing, Δ V_O		0.4	0.7		0.4	0.7		V
Maximum Sink Current		90	150		90	150		µA
Maximum Source Current		–2	–3		–2	–3		mA
Gain Band Width Product			1			1		MHz
Slew Rate			0.3			0.3		V/µS
Modulators/Drivers Section (From Compensation Terminal)								
Voltage Gain		11	12	13	10	12	14	dB
Output Swing		±1.6	±2.8		±1.6	±2.8		V
Driver Sink Current		500	700		500	700		µA
Driver Source Current		–15	–35		–15	–35		mA
Gain Band Width Product			25			25		MHz
Oscillator Section								
Initial Accuracy	T_J = 25°C	140	150	160	130	150	170	kHz
	$T_{MIN} \le T_J \le T_{MAX}$	130		170	120		180	kHz
Line Sensitivity	V_{IN} = 5 to 35V		.15	.35		.15	.60	%/V
Maximum Frequency	R_T = 10k, C_T = 10pF		5			5		MHz
Ext. Clock Low Threshold	Pin 1 (C_T) = V_{IN}	0.5			0.5			V
Ext. Clock High Threshold	Pin 1 (C_T) = V_{IN}			1.6			1.6	V
Status Indicator Section								
Input Voltage Window	@ E/A Inputs, V_{CM} = 1.5V	±135	±150	±165	±130	±150	±170	mV
Saturation Voltage	E/A Δ Input = 0V, I_{SINK} = 1.6mA			0.45			0.45	V
Max. Output Current	Pin 13 = 3V, E/A Δ Input = 0.0V	8	15		8	15		mA
Leakage Current	Pin 13 = 40V, E/A ΔInput = 0.2V		.05	1		.05	5	µA
Supply Current	V_{IN} = 35V		5	8		5	10	mA
UVLO Section								
Drivers Enabled Threshold	At Input Supply V_{IN}		3.9	4.5		3.9	4.5	V
Status Output Enabled Threshold	At Input Supply V_{IN}		3.9	4.5		3.9	4.5	V
Change in Reference Output	When V_{IN} Reaches UVLO Threshold		–2	–30		–2	–30	mV

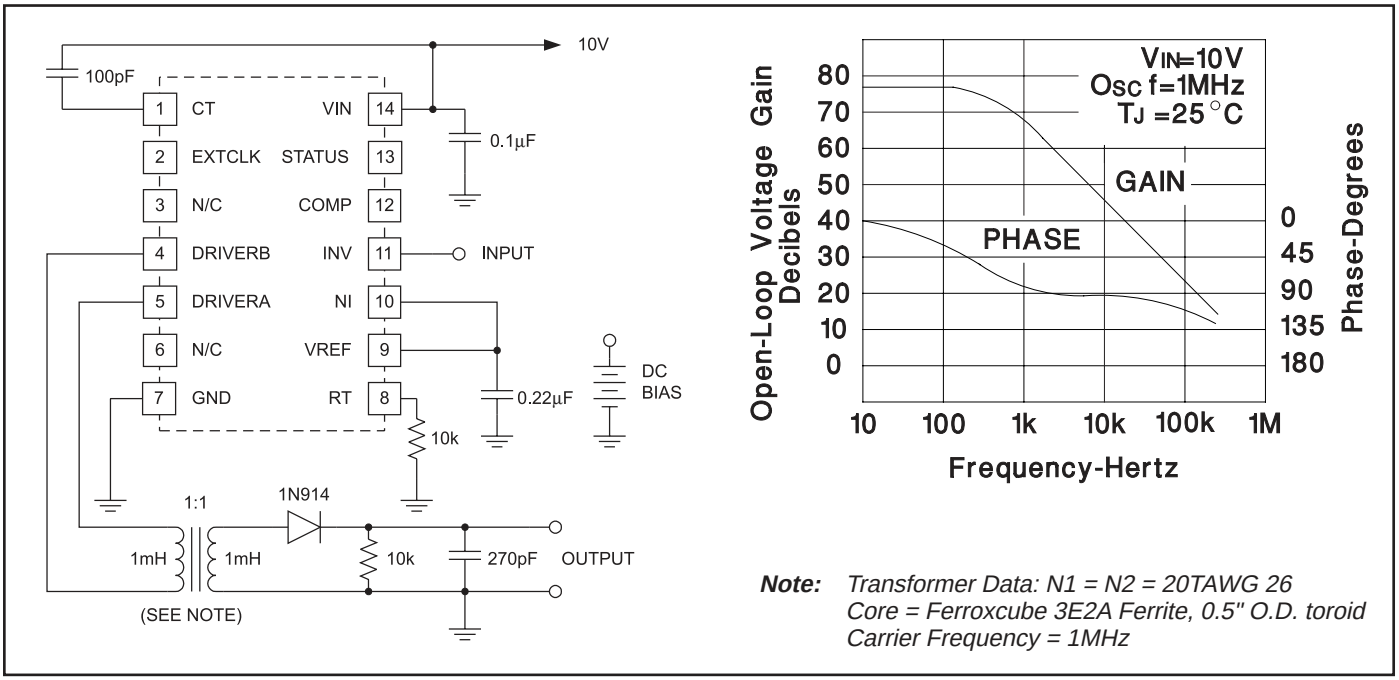


Figure 1. Transformer Coupled Open Loop Transfer Function

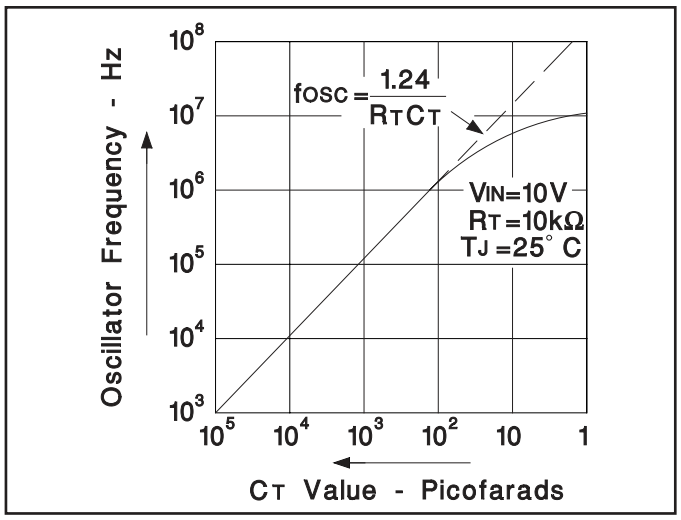


Figure 2. Oscillator Frequency

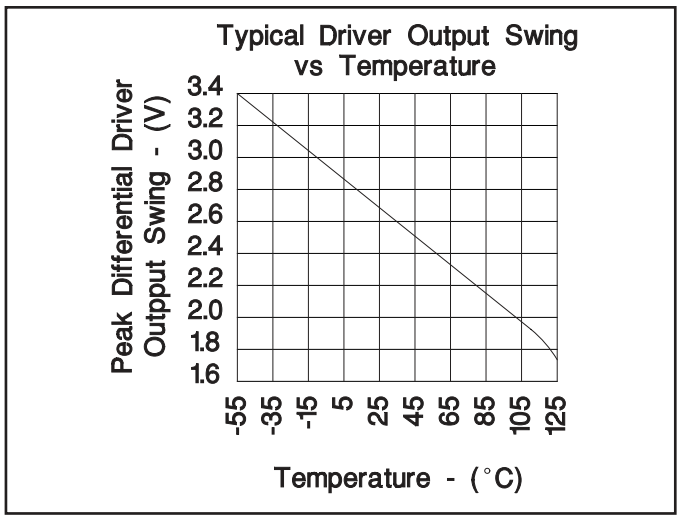


Figure 3. Typical Driver Output Swing vs Temperature

APPLICATION INFORMATION

The error amplifier compensation terminal, Pin 12, is intended as a source of feedback to the amplifier's inverting input at Pin 11. For most applications, a series DC blocking capacitor should be part of the feedback network. The amplifier is internally compensated for unity feedback.

The waveform at the driver outputs is a squarewave with an amplitude that is proportional to the error amplifier input signal. There is a fixed 12dB of gain from the error amplifier compensation pin to the modulator driver outputs. The frequency of the output waveform is controlled by either the internal oscillator or an external clock signal. With the internal oscillator the squarewave will have a fixed 50% duty cycle. If the internal oscillator is disabled by connecting Pin 1, C_R, to V_{IN} then the frequency and duty cycle of the output will be determined by the input clock waveform at Pin 2. If the oscillator remains disabled and there is not clock input at Pin 2, there will be a linear 12dB of signal gain to one or the other of the driver outputs depending on the DC state of Pin 2.

The driver outputs are emitter followers which will source a minimum of 15mA of current. The sink current, internally limited at 700µA, can be increased by adding resistors to ground at the driver outputs.

APPLICATION INFORMATION (continued)

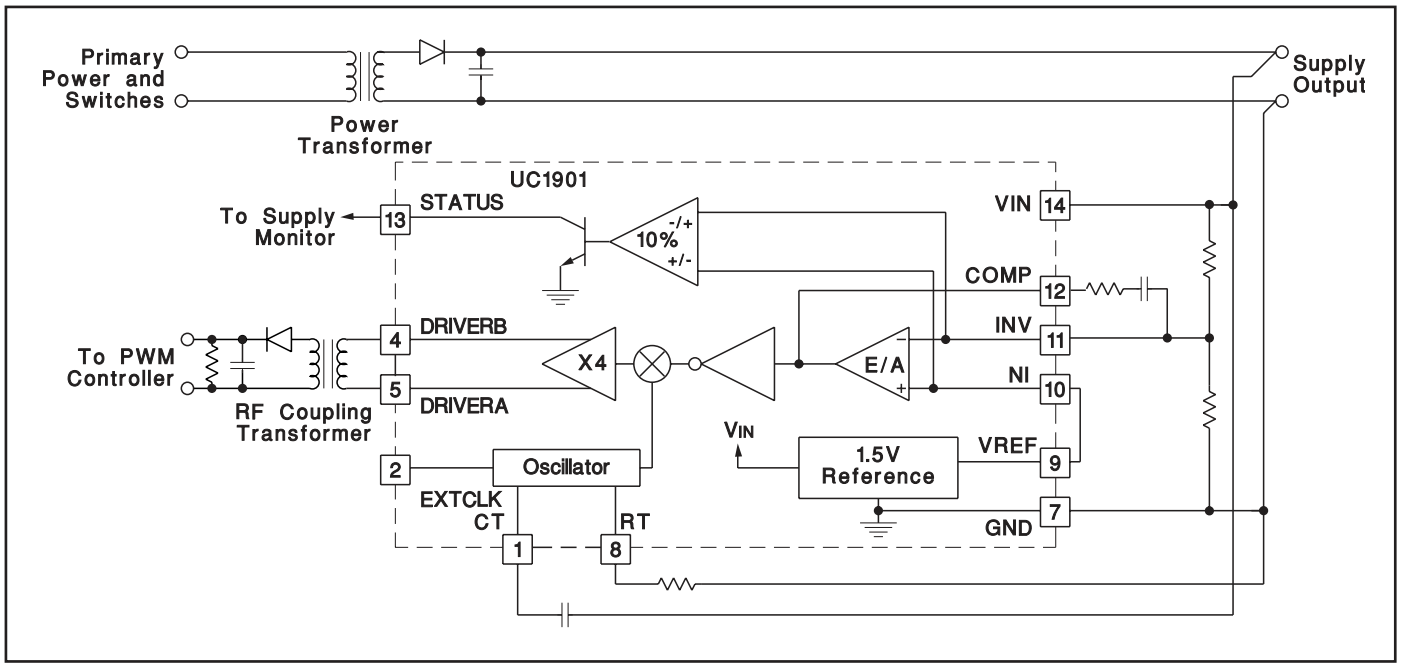


Figure 4. R.F. Transformer Coupled Feedback

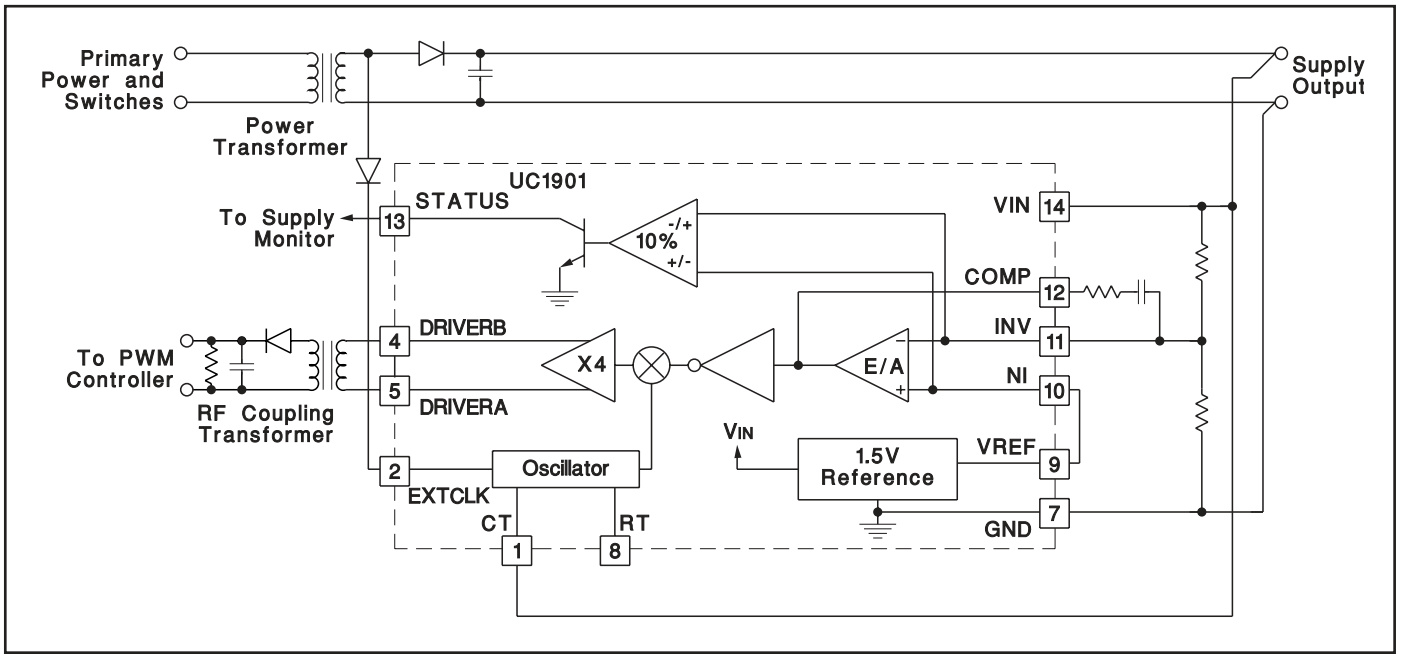
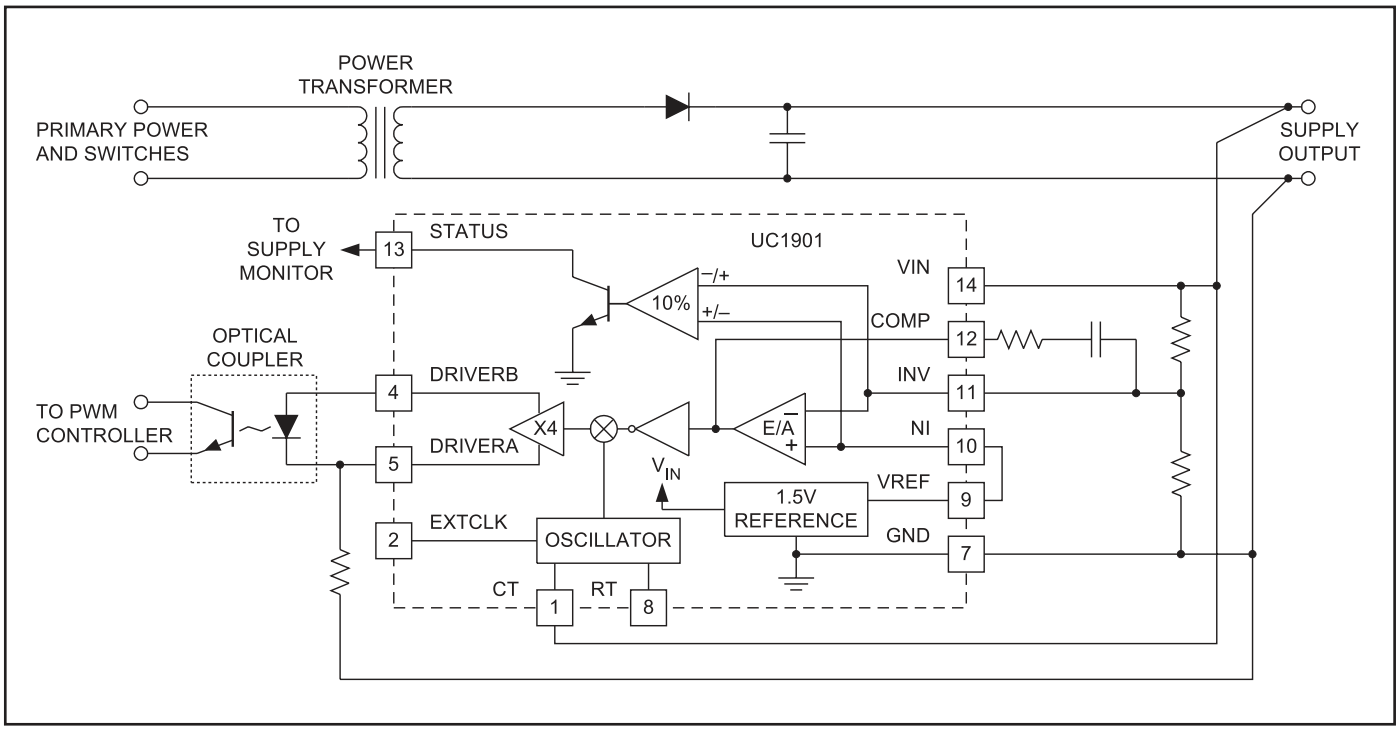


Figure 5. Feedback Coupled at Switching Frequency


POWER
TRANSFORMER
PRIMARY POWER
AND SWITCHES
SUPPLY
OUTPUT
TO
SUPPLY
MONITOR
13
STATUS
UC1901
VIN
14
10%
–/+
+/–
COMP
12
OPTICAL
COUPLER
DRIVERB
4
INV
11
TO PWM
CONTROLLER
X4
E/A
NI
10
DRIVERA
5
VIN
VREF
1.5V
REFERENCE
9
EXTCLK
2
OSCILLATOR
GND
7
CT
RT
1
8

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/ Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
5962-89441012A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Call TI	
5962-8944101CA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Call TI	
5962-8944101VCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
UC1901J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
UC1901J883B	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
UC1901L	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
UC1901L883B	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
UC2901D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC2901DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC2901DTR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC2901DTR/80209	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	
UC2901DTR/80209G4	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	
UC2901DTRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC2901J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
UC2901N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	
UC2901NG4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	
UC2901Q	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	
UC2901QG3	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	
UC3901D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC3901DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC3901DTR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/ Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
UC3901DTRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC3901DW	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC3901DWG4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC3901DWTR	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC3901DWTRG4	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
UC3901N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	
UC3901NG4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	
UC3901Q	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	
UC3901QG3	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	
UC3901QTR	ACTIVE	PLCC	FN	20	1000	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	
UC3901QTRG3	ACTIVE	PLCC	FN	20	1000	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

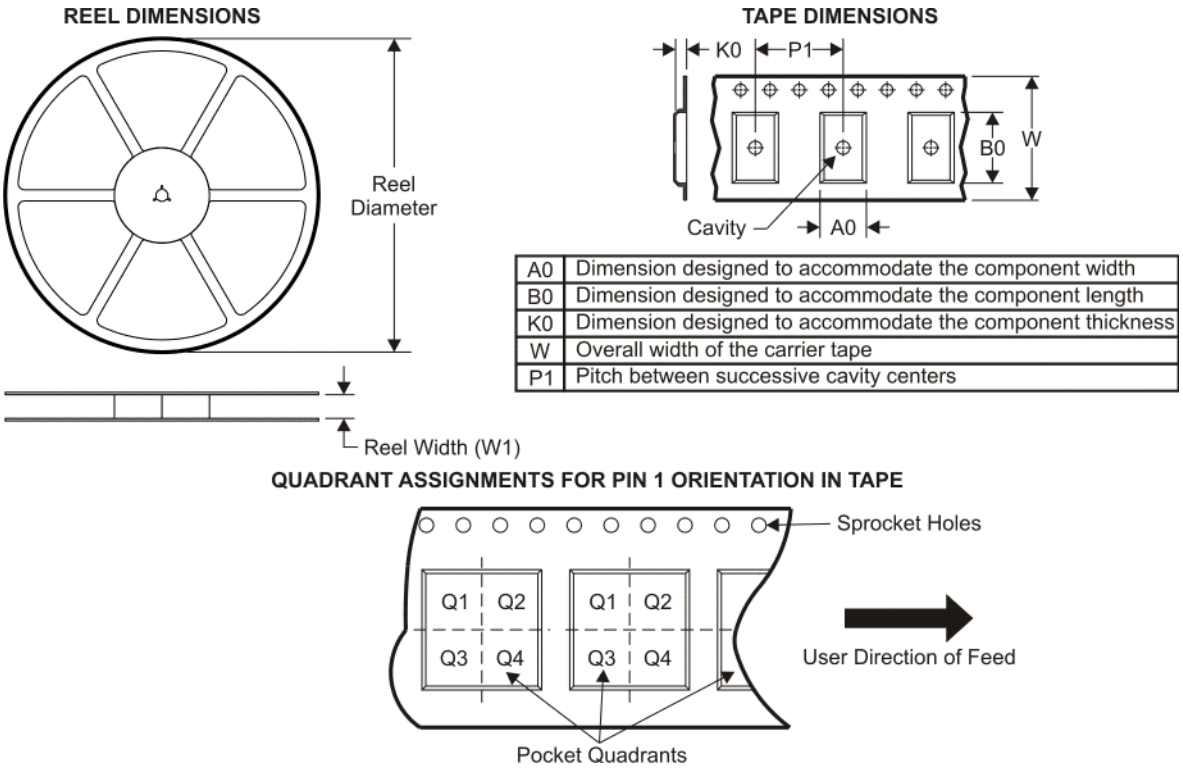
OTHER QUALIFIED VERSIONS OF UC1901, UC1901-SP, UC2901, UC3901 :

- Catalog: UC3901, UC1901
- Enhanced Product: UC2901-EP
- Military: UC1901
- Space: UC1901-SP, UC1901-SP

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

TAPE AND REEL INFORMATION

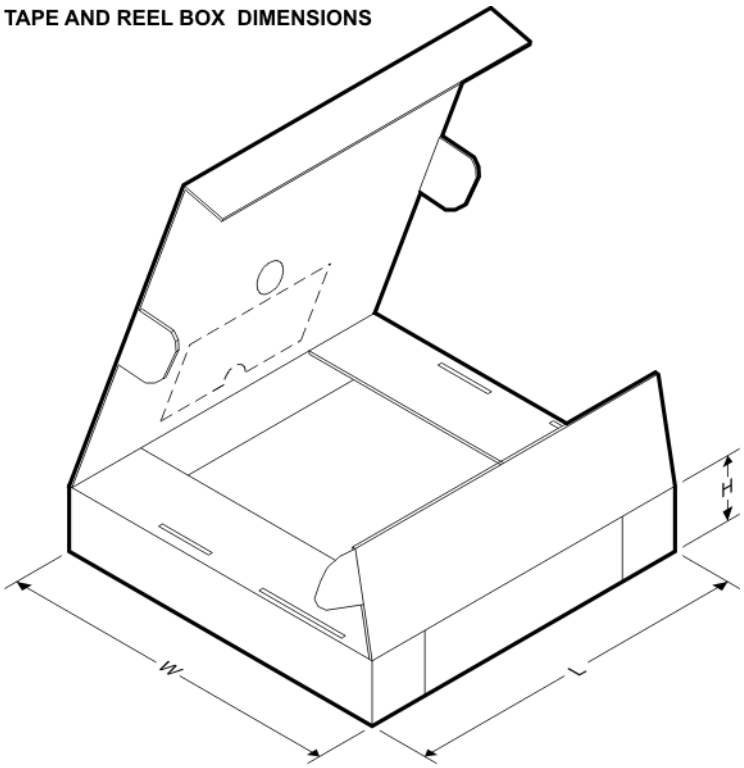


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UC2901DTR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
UC3901DTR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
UC3901DWTR	SOIC	DW	16	2000	330.0	16.4	10.85	10.8	2.7	12.0	16.0	Q1
UC3901QTR	PLCC	FN	20	1000	330.0	16.4	10.3	10.3	4.9	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UC2901DTR	SOIC	D	14	2500	346.0	346.0	33.0
UC3901DTR	SOIC	D	14	2500	346.0	346.0	33.0
UC3901DWTR	SOIC	DW	16	2000	346.0	346.0	33.0
UC3901QTR	PLCC	FN	20	1000	346.0	346.0	33.0

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DLP® Products	www.dlp.com	Energy and Lighting	www.ti.com/energy
DSP	dsp.ti.com	Industrial	www.ti.com/industrial
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Security	www.ti.com/security
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Power Mgmt	power.ti.com	Transportation and Automotive	www.ti.com/automotive
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Mobile Processors	www.ti.com/omap		
Wireless Connectivity	www.ti.com/wirelessconnectivity		
	TI E2E Community Home Page		e2e.ti.com

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